


PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	ANALOG MEMS SENSORS/24/15035	
1.3 Title of PCI	Standardization of new inner packing box including bubble wrap for MEMS inertial products with package 2x2mm.	
1.4 Product Category	Pls refer to the products list.	
1.5 Issue date	2024-10-25	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	PIKE EMMA
2.1.2 Phone	+44 1628896111
2.1.3 Email	emma.pike@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Simone FERRI
2.1.2 Marketing Manager	Tarik SOUBES
2.1.3 Quality Manager	Fabio BIGANZOLI

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	Any indirect material modifications for shipping products in dimensions, material, composition, orientation	CALAMBA

4. Description of change

	Old	New
4.1 Description	No bubble wrap	Bubble wrap and FRAGILE label.
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact	

5. Reason / motivation for change

5.1 Motivation	The change in reel packing is implemented to guarantee more protection against the impacts during the transport and shipment.
5.2 Customer Benefit	LOGISTICS IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	Date Code
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7. Timing / schedule

7.1 Date of qualification results	2024-11-25
7.2 Intended start of delivery	2024-12-09
7.3 Qualification sample available?	Not Applicable

8. Qualification / Validation

8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)

15035 Public product.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	LIS2DU12TR	
	LIS2DUX12TR	
	LIS2DUXS12TR	

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